

UART-to-UART Bridge Using Low-Memory MSP430™ MCUs



Introduction

The universal asynchronous receiver transmitter (UART) interface enables serial communication between the MSP430™ microcontroller (MCU) and another device, such as a personal computer (PC), host MCU, or host processor. Both devices must operate at the same baud rate to communicate. Common baud rates range from 1200 baud to 115200 baud but can reach up to 921600 baud. Basically, a higher baud rate means that the data is sent and received faster. Some designs may require connecting two devices with different baud rates. If these baud rates are fixed, a UART-to-UART bridge is needed to translate the baud rates. The MSP430FR2000 MCU can be used as a low-cost UART-to-UART bridge by using its enhanced universal serial communication interface (eUSCI) UART module and its Timer module. To get started, [download project files and a code example](#) demonstrating this functionality.

Implementation

Figure 1 shows the block diagram for the UART-to-UART bridge. The MSP-TS430PW20 target development board was used for connecting the peripherals to the MSP430FR2000 MCU. First, ensure that jumpers JP14 and JP15 are populated (leave JP13 unpopulated), that jumper J16 is set to UART, and that jumpers JP11, JP17, and JP18 are all removed. These jumper settings allow the backchannel UART interface on the MSP-FET programmer tool to simulate the target device, which has the lower baud rate. Using jumper wires, connect J4.14 (P2.0) to JP11.3, and connect J4.13 (P2.1) to JP11.4. To simulate the host device, which has the higher baud rate, use a USB serial adapter that features USB-to-TTL-level conversion and a maximum baud rate greater than 1 Mbaud. Connect the TX signal to J4.16 (P1.6), connect the RX signal to J4.15 (P1.7), and connect the GND signal to J2.2 (GND).

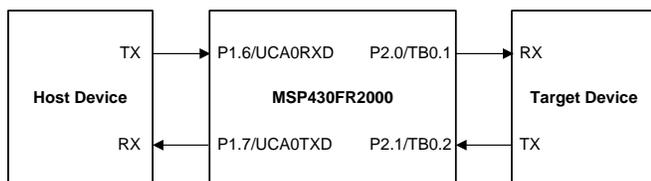


Figure 1. UART-to-UART Bridge Block Diagram

Using a PC, open a new serial connection with a terminal program like [Tera Term](#), and connect to the back-channel UART interface on the MSP-FET by selecting the COM port called *MSP Application UART1*. In the first terminal window, change the baud rate to 9600. Next, open another serial connection, and connect to the UART interface on the USB serial adapter by selecting the appropriate COM port. In the second terminal window, change the baud rate to 921600. These two terminal windows will simulate the host and target devices. To demonstrate the functionality of the UART-to-UART bridge, enter a character in either terminal, press *Enter*, and it will be displayed in the other terminal.

In the firmware, the main code initializes the digitally controlled oscillator (DCO), the hardware UART pins and eUSCI UART module, and the software UART pins and Timer module. Then, the central processing unit (CPU) goes to sleep by entering low-power mode 0 (LPM0). When the MCU receives hardware or software UART interrupts, the CPU wakes up, enters active mode, captures the UART data, and then transmits the received data as quickly as possible before going back to sleep.

Figure 2 shows the flowchart for the hardware and software UART code.

When UART data is received by the hardware UART RX pin (P1.6), the UCRXIFG interrupt flag is set, and the data bits are read from the UART RX buffer, UCRXBUF. Next, the Timer module is started and then delayed repeatedly to send the start bit, the eight data bits, and the stop bit using the software UART TX pin (P2.0).

The software UART RX pin (P2.1) is initially configured as general purpose input-output (GPIO) that provides an interrupt on the falling edge of the input signal.

When UART data is received by P2.1, the falling edge of the start bit triggers this interrupt flag. Next, the Timer module is started and then delayed repeatedly to read the eight data bits in the middle of each bit (see [Figure 3](#)). The data bits are placed in the UART TX buffer and sent using the hardware UART TX pin (P1.7).

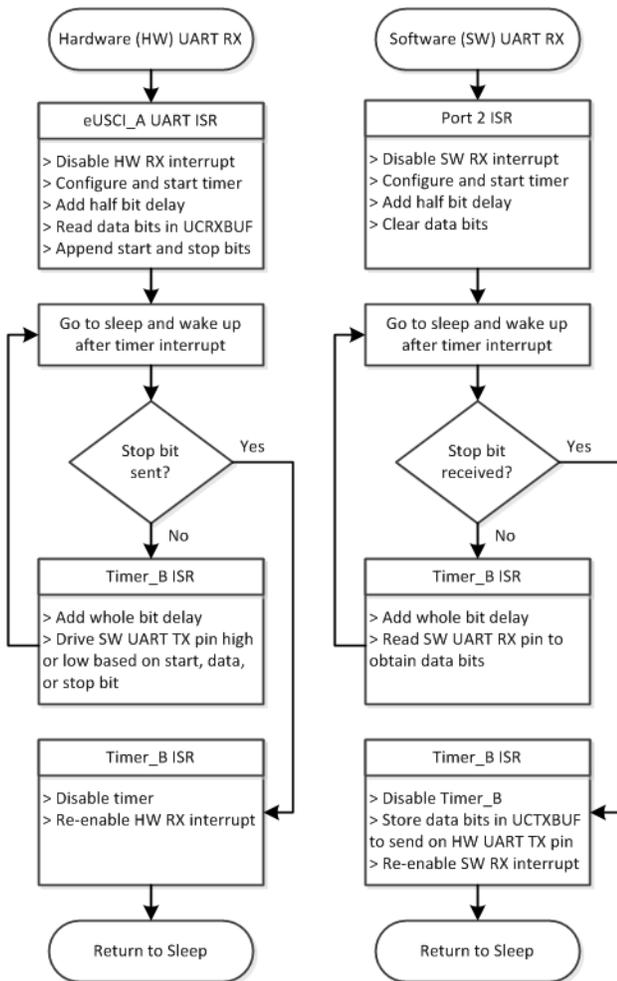


Figure 2. Hardware and Software UART RX and TX Code Flow

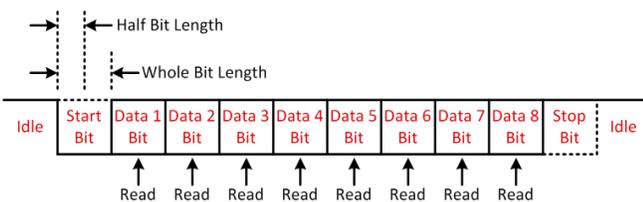


Figure 3. UART Packet and Timings for Reading Software UART Data

Performance

The firmware supports half-duplex UART communication only, which means one direction at a time. It also supports UART packets with 8 data bits, least significant bit (LSB) first, no parity bit, and one stop bit. To maximize the performance of the MSP430FR2000 MCU, always connect the hardware UART interface to the device with the higher baud rate.

When two consecutive UART packets are received by the hardware UART interface, the first packet is processed while the next packet is stored in UCRXBUF. For more than two consecutive packets, these will be skipped because there is only one receive buffer. This limitation does not affect the software UART interface.

To change the baud rate of the hardware UART interface, see the [MSP430FR4xx and MSP430FR2xx Family User's Guide](#) for the proper configuration. To change the baud rate of the software UART interface, change the *WHOLE_BIT* definition in the code, which equals the subsystem master clock (SMCLK) divided by the baud rate. The *HALF_BIT* definition is just half this value. Figure 3 shows these bit length delays. In this example, SMCLK operates at 16 MHz. After changing these definitions, rebuild the code. Table 1 lists the maximum baud rates supported by both interfaces in this example.

Table 1. Maximum Baud Rates

UART Interface	Maximum Baud Rate
Hardware	921600
Software	38400

Table 2 lists the delay between receiving and sending the UART packets. To reduce code size, the same Timer initialization function is used by the software UART receive and transmit code, which delays by half bit length. Lower baud rates increase the delay.

Table 2. Delay Between UART Packets

UART Packet Flow	RX Baud Rate	TX Baud Rate	Delay (µs)	Average Delay (µs)
HW RX to SW TX	921600	38400	21	22
SW RX to HW TX	38400	921600	23	
HW RX to SW TX	921600	9600	60	58.5
SW RX to HW TX	9600	921600	57	

LPM0 reduces power consumption while the MCU is not receiving or transmitting data. Other LPMs may achieve lower power consumption, but they may require an external crystal oscillator and may limit the maximum baud rate due to increased wake-up times.

To implement more advanced features such as adding support for flow control, multi-byte receive buffers, odd or even parity bits, multiple stop bits, and CRC error detection, it may be necessary to upgrade to the 1KB MSP430FR2100 MCU.

Device Recommendations

The device used in this example is part of the MSP430 Value Line Sensing portfolio of low-cost MCUs, designed for sensing and measurement applications. This example can be used with the devices shown in [Table 3](#) with minimal code changes. For more information on the entire Value Line Sensing MCU portfolio, visit www.ti.com/MSP430ValueLine.

Table 3. Device Recommendations

Part Number	Key Features
MSP430FR2000	0.5KB FRAM, 0.5KB RAM, eComp
MSP430FR2100	1KB FRAM, 0.5KB RAM, 10-bit ADC, eComp
MSP430FR2110	2KB FRAM, 1KB of RAM, 10-bit ADC, eComp
MSP430FR2111	3.75KB FRAM, 1KB RAM, 10-bit ADC, eComp

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